

Form PTO 1449
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LIST OF REFERENCES CITED BY APPLICANT

APPLICANT

Benoit BARRIERE et al.

FILING DATE

April 2, 2001

GROUP

Not Yet Issued

U.S. PATENT DOCUMENTS

| EXAMINER INITIAL | | DOCUMENT NUMBER | DATE | NAME | CLASS | SUB CLASS | FILING DATE IF APPROPRIATE |
|---------------------|----|--------------------|----------|---------------|-------|--------------|-------------------------------|
| <i>W</i> | AA | 4,740,562 | 04-26-88 | Menke et al. | 525 | 366 | |
| <i>W</i> | AB | *6,080,487 | 06-27-00 | Coggio et al. | 428 | 422 | |
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| <i>W</i> | AO | EP 1 054 023 A1 | 11-22-00 | Europe | | X |
| <i>W</i> | AP | WO 97/27260 | 07-31-97 | PCT | X | |
| <i>W</i> | AQ | *WO 98/08879 | 03-05-98 | PCT | X | |
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OTHER REFERENCES (Including Author, Title, Date, Pertinent Pages, etc.)

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| <i>W</i> | AW | Abstract of Japan - XP002160893 - Title - "Surface modification of tetrafluoroethylene-perfluoroalkyl vinyl ether copolymer (PFA) by remote hydrogen plasma and surface metallization with electroless plating of copper metal", Macromolecules, December 1999, Vol. 32, No. 25, pp. 8566-71. |
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Examiner

J. Legner

Date Considered

1/31/03

*Examiner: Initial if reference is considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

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11000 U.S. PAT. NO. 09/822825

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